

MOSFET – N 沟道 POWERTRENCH®

60 V, 100 A, 3 mΩ

FDMS030N06B

说明

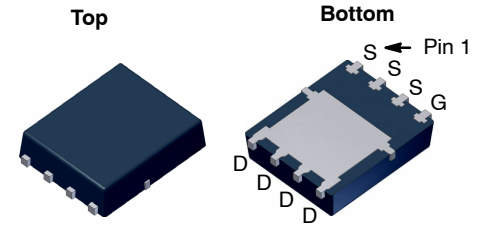
此 N 沟道 MOSFET 采用安森美 (onsemi) 先进的 POWERTRENCH 工艺生产，这一先进工艺是专为最大限度地降低导通电阻并保持卓越开关性能而定制的。

特性

- $R_{DS(on)} = 2.4 \text{ m}\Omega$ (典型值) @ $V_{GS} = 10 \text{ V}$, $I_D = 50 \text{ A}$
- 低 $R_{DS(on)}$ 和高效的先进硅封装组合
- 快速开关速度
- 100% 经过 UIL 测试
- 符合 RoHS 标准

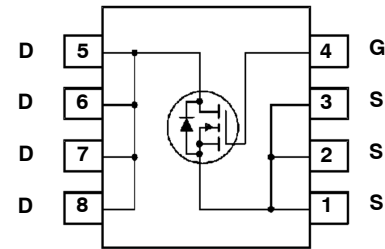
应用

- 用于 ATX / 服务器 / 电信 PSU 的同步整流
- 电池保护电路
- 电机驱动和不间断电源
- 可再生系统

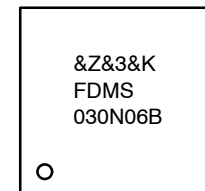


PQFN8 5 × 6, 1.27P
(Power 56)
CASE 483AE

PIN CONNECTIONS



MARKING DIAGRAM



&Z = Assembly Plant Code
 &3 = 3-Digit Date Code
 &K = 2-Digit Lot Run Traceability Code
 FDMS030N06B = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping [†]
FDMS030N06B	PQFN8 (Pb-Free, Halide Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, [BRD8011/D](#).

FDMS030N06B

最大额定值 ($T_C = 25^\circ\text{C}$ 除非另有说明。)

符号	参数			FDMS030N06B	单位
V _{DSS}	漏极－源极电压			60	V
V _{GSS}	栅极－源极电压			±20	V
I _D	漏极电流	连续 (说明 1)	T _C = 25°C	100	A
		连续 (说明 2a)	T _A = 25°C	22.1	
I _{DM}	漏极电流	脉冲 (说明 3)		400	
E _{AS}	单脉冲雪崩能量 (说明 4)			248	mJ
P _D	功耗	T _C = 25°C		104	W
		T _A = 25°C (说明 2a)		2.5	
T _J , T _{STG}	工作和存储温度范围			−55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

(参考译文)

如果电压超过最大额定值表中列出的值范围，器件可能会损坏。如果超过任何这些限值，将无法保证器件功能，可能会导致器件损坏，影响可靠性。

热性能

符号	参数	FDMS030N06B	单位
$R_{\theta JC}$	结至外壳热阻最大值	1.2	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	结至环境热阻最大值 (说明 2a)	50	

电气特性 ($T_C = 25^\circ\text{C}$ 除非另有说明。)

符号	参数	测试条件	最小值	典型值	最大值	单位
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关断特性

BV_{DSS}	漏极-源极击穿电压	$I_D = 250\ \mu\text{A}, V_{GS} = 0\ \text{V}$	60	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	击穿电压温度系数	$I_D = 250\ \mu\text{A}$, 推荐选用 25°C	-	0.03	-	$\text{V}/^\circ\text{C}$
I_{DSS}	零栅极电压漏极电流	$V_{DS} = 48\ \text{V}, V_{GS} = 0\ \text{V}$	-	-	1	μA
I_{GSS}	栅极-体漏电流	$V_{GS} = \pm 20\ \text{V}, V_{DS} = 0\ \text{V}$	-	-	± 100	nA

导通特性

$V_{GS(th)}$	栅极阈值电压	$V_{GS} = V_{DS}, I_D = 250\ \mu\text{A}$	2.5	3.3	4.5	V
$R_{DS(on)}$	漏极至源极静态导通电阻	$V_{GS} = 10\ \text{V}, I_D = 50\ \text{A}$	-	2.4	3.0	m Ω
g_{FS}	正向跨导	$V_{DS} = 10\ \text{V}, I_D = 50\ \text{A}$	-	119	-	S

动态特性

C_{iss}	输入电容	$V_{DS} = 30\ \text{V}, V_{GS} = 0\ \text{V}, f = 1\ \text{MHz}$	-	5685	7560	pF
C_{oss}	输出电容		-	1720	2290	pF
C_{rss}	反向传输电容		-	59	-	pF
$C_{oss(er)}$	能量相关输出电容	$V_{DS} = 30\ \text{V}, V_{GS} = 0\ \text{V}$	-	2504	-	pF
$Q_{g(tot)}$	10 V 的栅极电荷总量	$V_{DS} = 30\ \text{V}, I_D = 50\ \text{A}, V_{GS} = 0\ \text{V to } 10\ \text{V}$ (说明 5)	-	75	-	nC
Q_{gs}	栅极-源极栅极电荷		-	30	-	nC
Q_{gd}	栅极-漏极“米勒”电荷		-	14	-	nC
$V_{plateau}$	栅极平台电压		-0	5.4	-	V
Q_{sync}	总栅极电荷同步	$V_{DS} = 0\ \text{V}, I_D = 50\ \text{A}$	-	66.2	-	nC
Q_{oss}	输出电荷	$V_{DS} = 30\ \text{V}, V_{GS} = 0\ \text{V}$	-	174	-	nC

电气特性 ($T_C = 25^\circ\text{C}$ 除非另有说明。)

符号	参数	测试条件	最小值	典型值	最大值	单位
ESR	等效串联电阻	$f = 1\text{ MHz}$	–	1.05	–	Ω

开关特性

$t_{d(on)}$	导通延迟时间	$V_{DD} = 30\text{ V}, I_D = 50\text{ A}, V_{GS} = 10\text{ V},$ $R_{GEN} = 4.7\ \Omega$ (说明 5)	–	39	88	ns
t_r	开通上升时间		–	20	50	ns
$t_{d(off)}$	关断延迟时间		–	52	114	ns
t_f	关断下降时间		–	16	42	ns

漏极 – 源极二极管特性

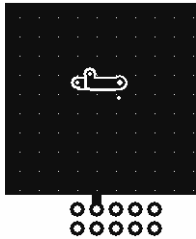
I_S	漏极-源极二极管最大正向连续电流		–	–	100	A
I_{SM}	漏极 – 源极二极管最大正向脉冲电流		–	–	400	A
V_{SD}	漏极-源极二极管正向电压	$V_{GS} = 0\text{ V}, I_{SD} = 50\text{ A}$	–	–	1.25	V
t_{rr}	反向恢复时间	$V_{GS} = 0\text{ V}, I_{SD} = 50\text{ A},$ $di_F/dt = 100\text{ A}/\mu\text{s}$	–	71	–	ns
Q_{rr}	反向恢复电荷		–	85	–	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

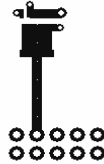
(参考译文)

除非另有说明, “电气特性”表格中列出的是所列测试条件下的产品性能参数。如果在不同条件下运行, 产品性能可能与“电气特性”表格中所列性能参数不一致。

1. 硅限制 I_D 额定值 = 147 A。
2. $R_{\theta JA}$ 取决于安装在 FR-4 材质 1.5 x 1.5 in. 电路板上 1 in² 焊盘和 2 盎司铜焊盘上的器件。 $R_{\theta JC}$ 通过设计保证, 而 $R_{\theta CA}$ 取决于用户的电路板设计。



a) 50°C/W 安装于
1 in² 2 盎司焊盘。



b) 125°C/W 安装于
最小尺寸的 2 盎司焊盘。

3. 重复额定值: 脉冲宽度受限于最大结温。
4. $L = 0.3\text{ mH}, I_{AS} = 40.7\text{ A}, V_{DD} = 50\text{ V}, V_{GS} = 10\text{ V}$, 开始 $T_J = 25^\circ\text{C}$ 。
5. 本质上独立于工作温度的典型特性。

典型性能特征

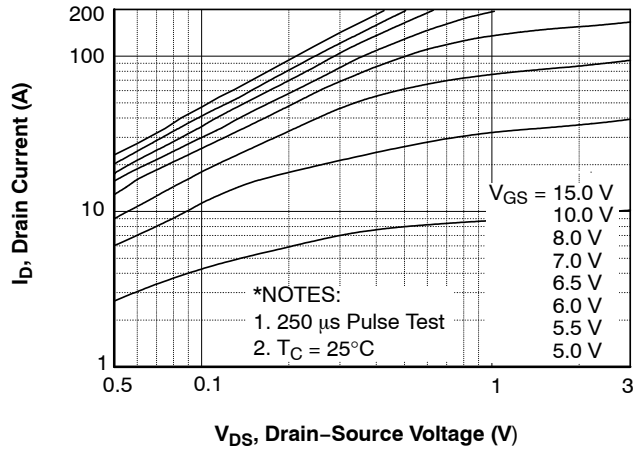


图 1. 导通区域特性

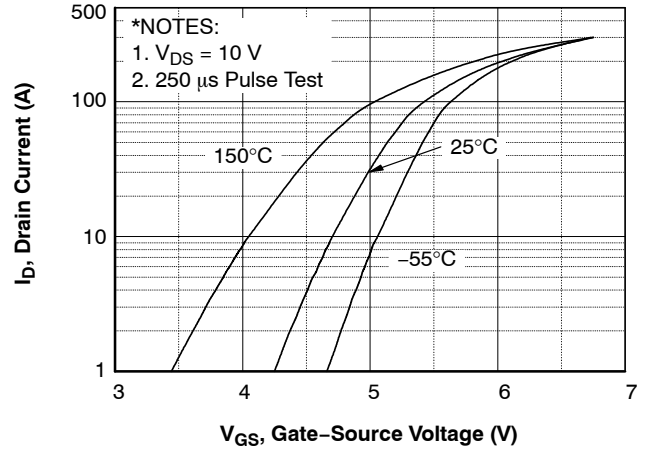


图 2. 传输特性

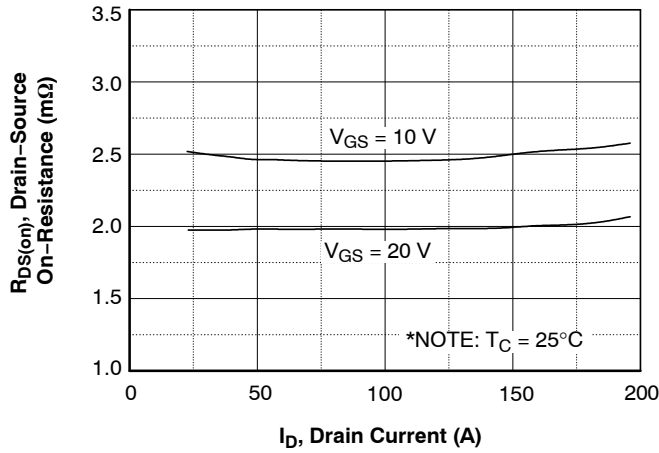


图 3. 导通电阻变化与漏极电流和栅极电压

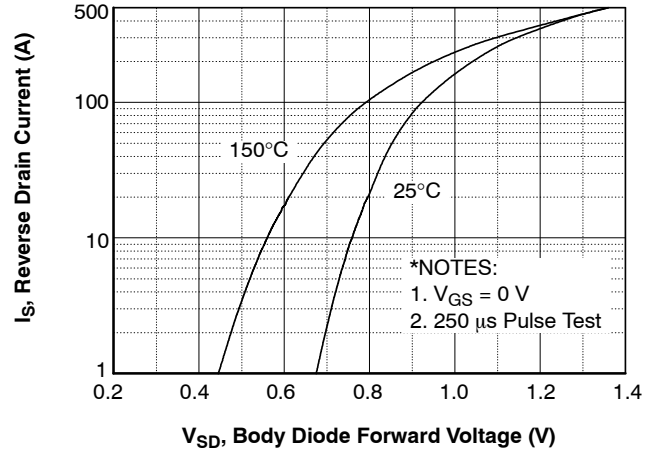


图 4. 体二极管正向电压变化与源极电流和温度

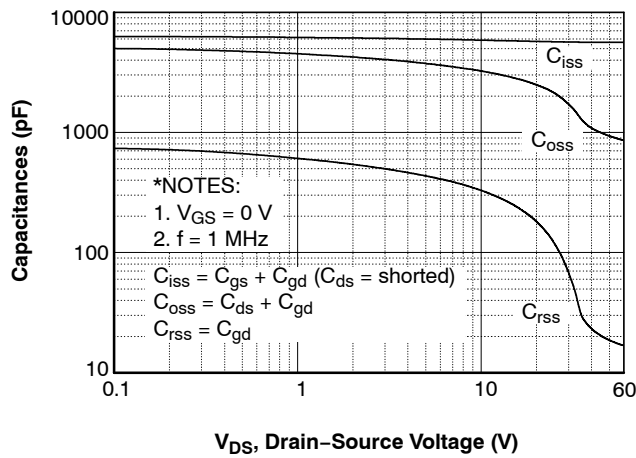


图 5. 电容特性

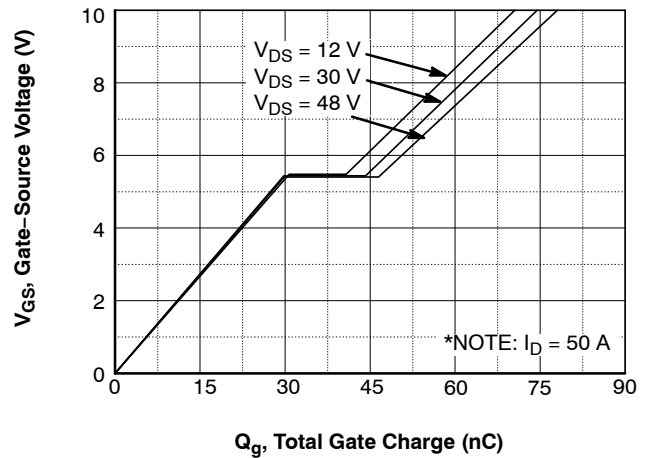


图 6. 栅极电荷

典型性能特征 (接上页)

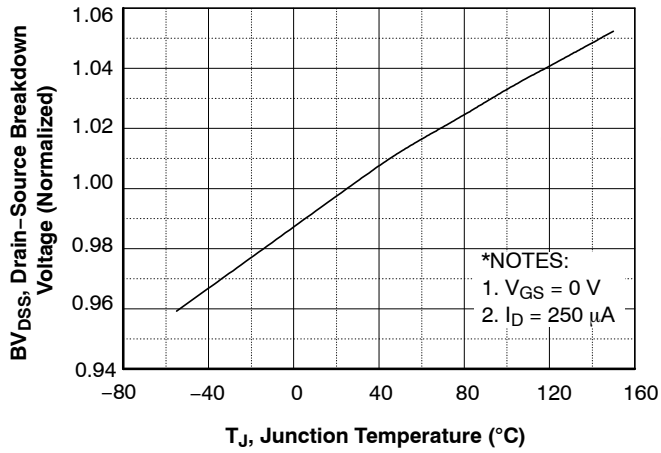


图 7. 击穿电压变化与温度

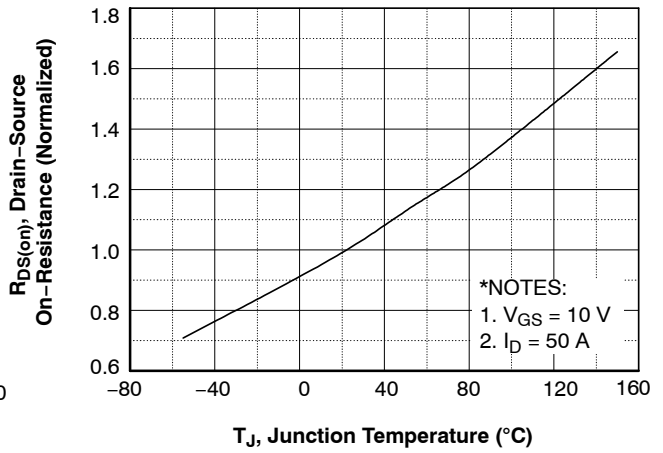


图 8. 导通电阻变化与温度

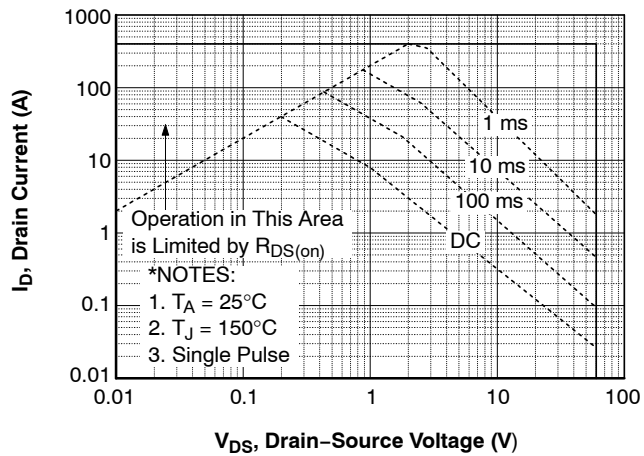


图 9. 最大安全工作区

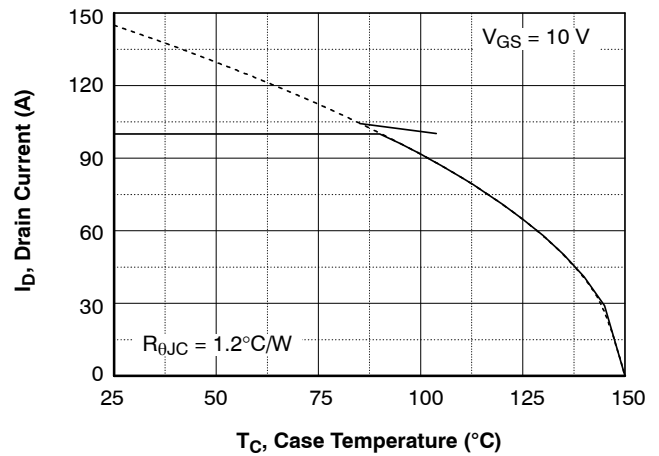


图 10. 最大漏极电流与外壳温度

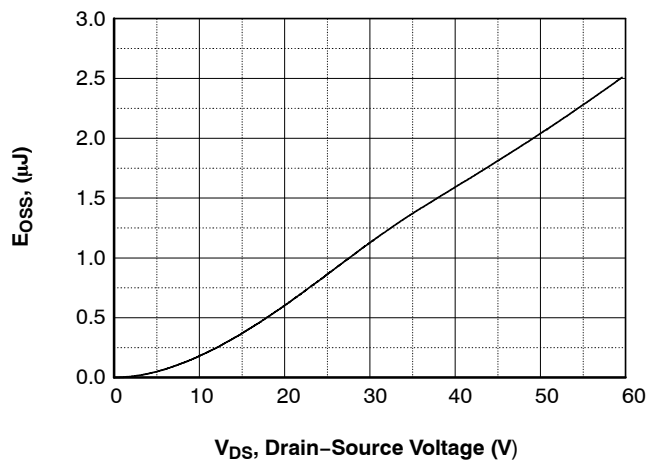
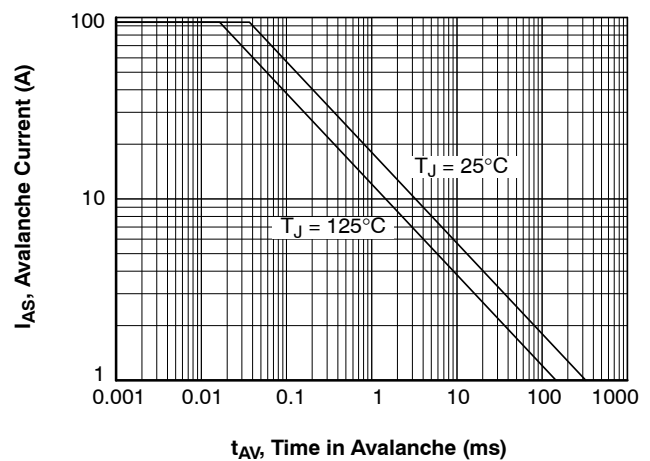
图 11. 输出电容 (E_{oss}) 与漏极 - 源极电压

图 12. 非箝位电感开关能力

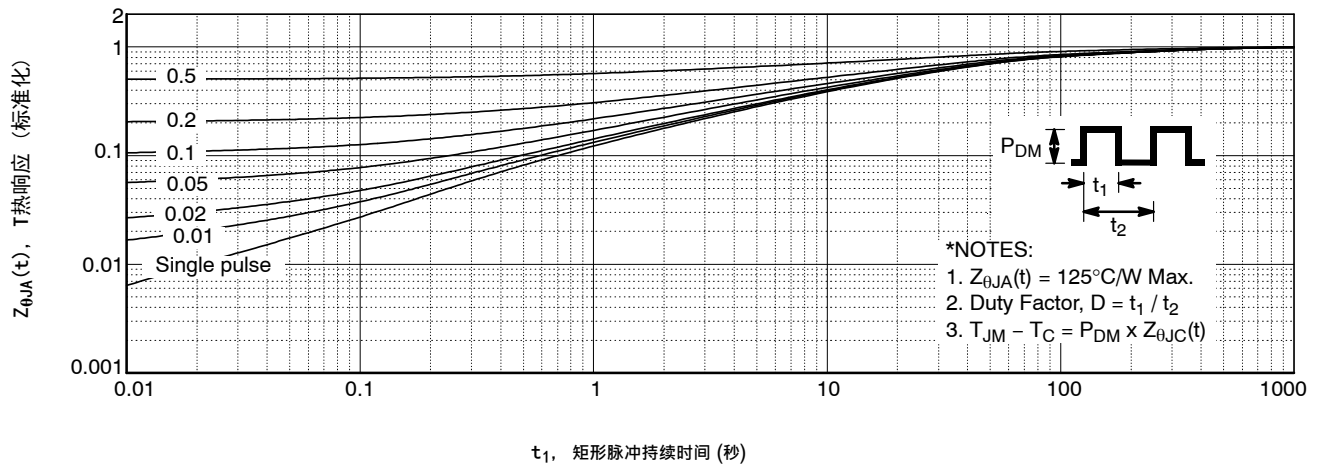


图 13. 瞬态热响应曲线

典型性能特征 (接上页)

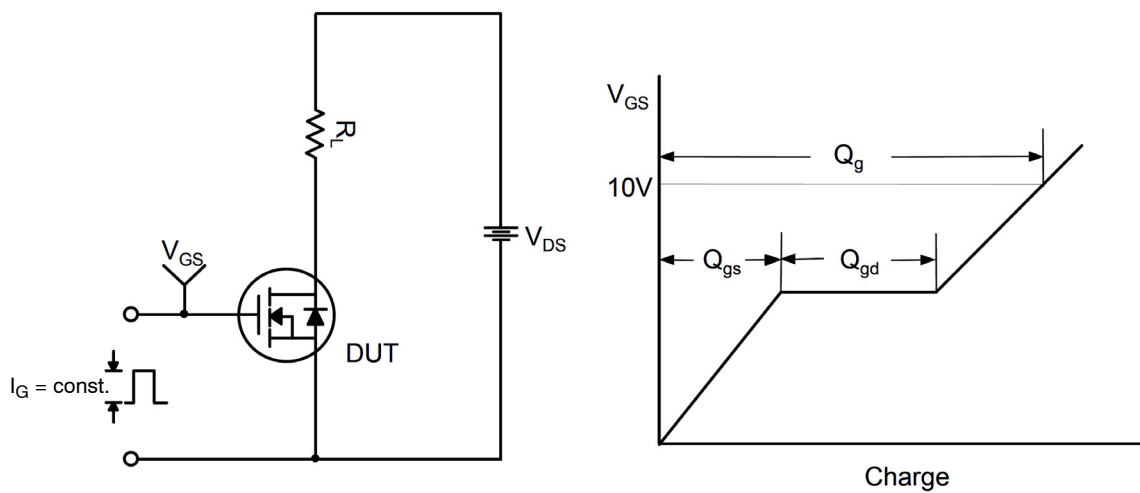


图 14. 栅极电荷测试电路与波形

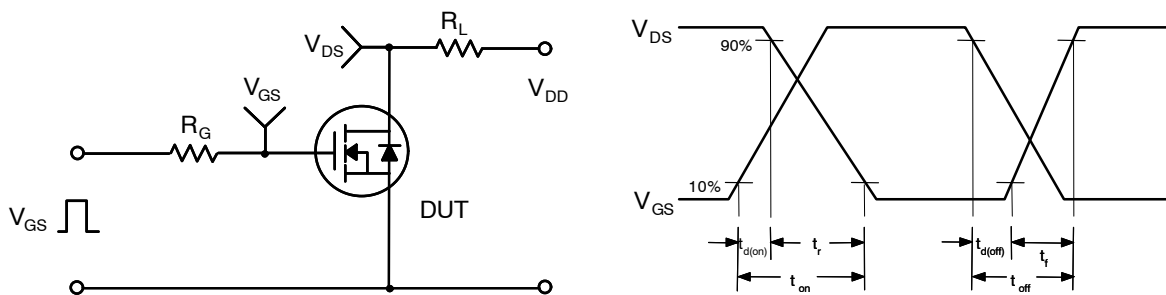


图 15. 阻性开关测试电路与波形

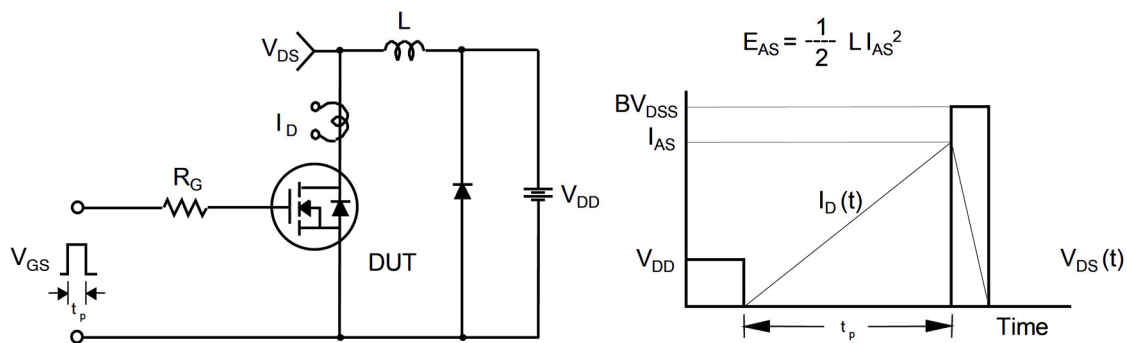
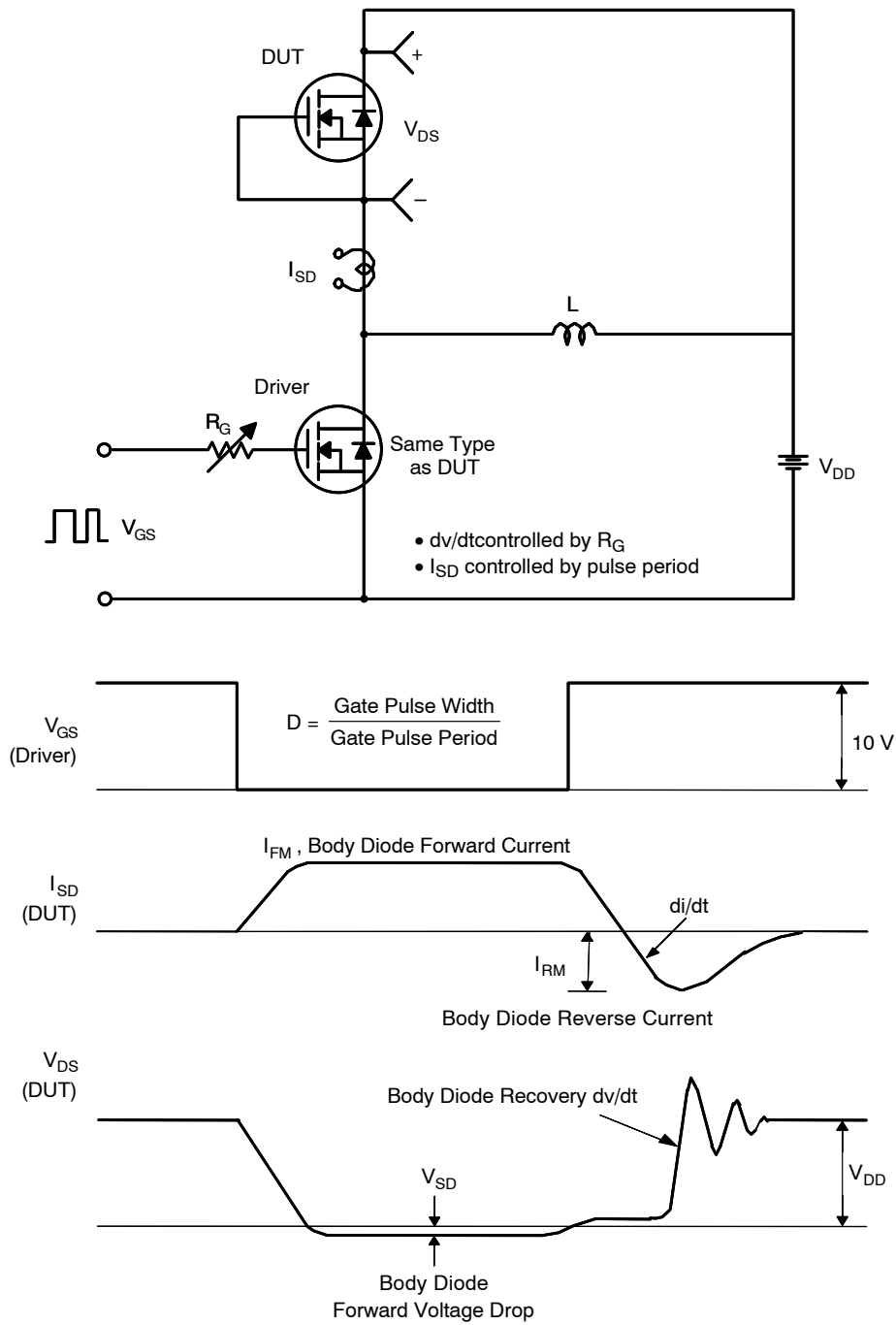
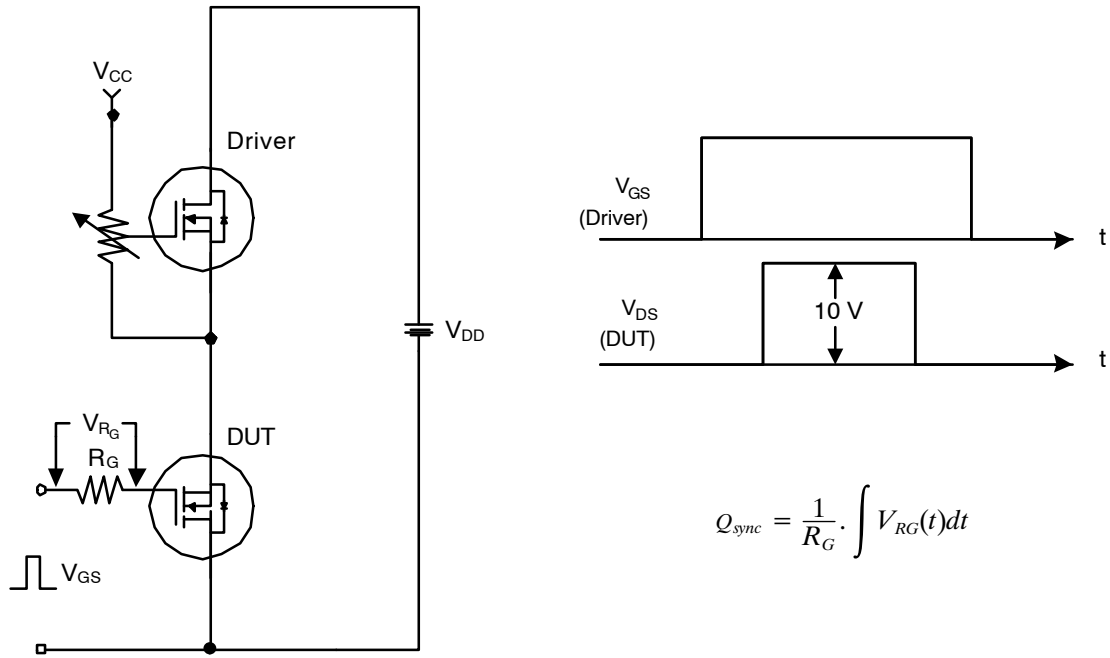
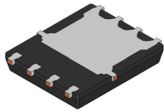


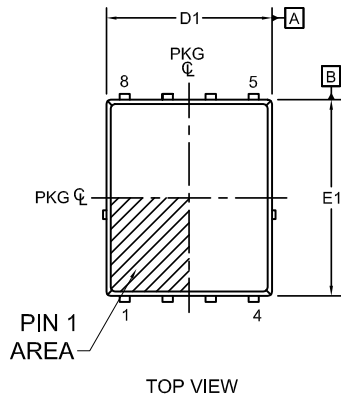
图 16. 非箝位电感开关能力

图 17. 二极管恢复 dv/dt 峰值测试电路与波形

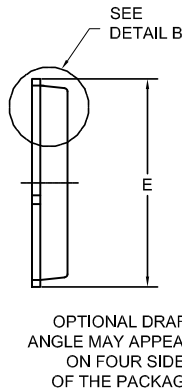
图 18. 总栅极电荷 Q_{sync} 测试电路与波形


PQFN8 5X6, 1.27P
CASE 483AE
ISSUE C

DATE 21 JAN 2022

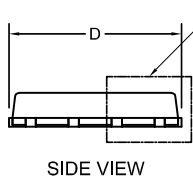


TOP VIEW

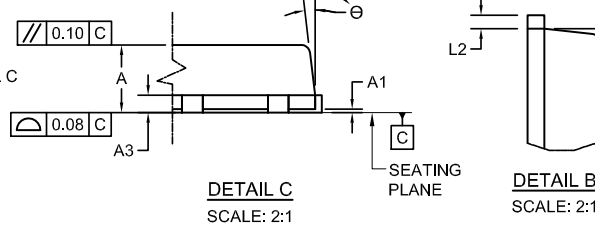
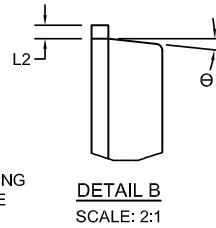
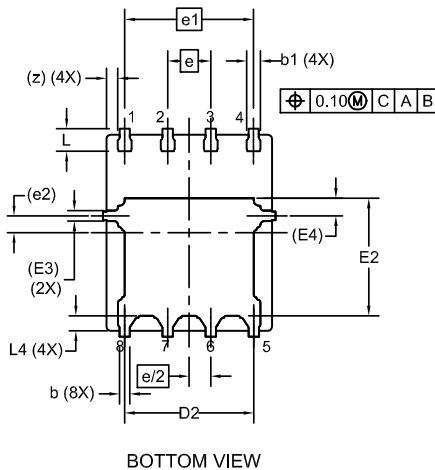

OPTIONAL DRAFT
ANGLE MAY APPEAR
ON FOUR SIDES
OF THE PACKAGE

NOTES:

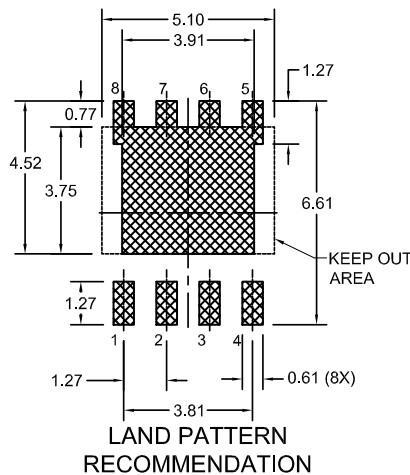
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. COPLANARITY APPLIES TO THE EXPOSED PADS AS WELL AS THE TERMINALS.
4. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.
5. SEATING PLANE IS DEFINED BY THE TERMINALS. "A1" IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.
6. IT IS RECOMMENDED TO HAVE NO TRACES OR VIAS WITHIN THE KEEP OUT AREA.



SIDE VIEW


DETAIL C
SCALE: 2:1

DETAIL B
SCALE: 2:1


BOTTOM VIEW


LAND PATTERN
RECOMMENDATION

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERM/D.

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.90	1.00	1.10
A1	0.00	-	0.05
b	0.21	0.31	0.41
b1	0.31	0.41	0.51
A3	0.15	0.25	0.35
D	4.90	5.00	5.20
D1	4.80	4.90	5.00
D2	3.61	3.82	3.96
E	5.90	6.15	6.25
E1	5.70	5.80	5.90
E2	3.38	3.48	3.78
E3	0.30 REF		
E4	0.52 REF		
e	1.27 BSC		
e/2	0.635 BSC		
e1	3.81 BSC		
e2	0.50 REF		
L	0.51	0.66	0.76
L2	0.05	0.18	0.30
L4	0.34	0.44	0.54
z	0.34 REF		
Θ	0°	-	12°

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DESCRIPTION: PQFN8 5X6, 1.27P

PAGE 1 OF 1

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